## 101223C

FB85-10 85 MHz Bandpass Filter 10 MHz Bandwidth

## Specifications

| Parameter | Symbol | Min | Typical | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Center Frequency | $\mathrm{F}_{0}$ |  | 85 |  | MHz |
| Bandwidth | B |  | 10 |  | MHz |
| -3 dB Bandwidth | $\mathrm{B}_{3}$ | 11.2 | 11.3 |  | MHz |
| -40 dB Bandwidth | $\mathrm{B}_{40}$ |  | 13 | 13.1 | MHz |
| Delay | $\mathrm{T}_{0}$ | 1.61 | 1.617 | 1.62 | Hsec |
| Insertion Loss | IL |  | 22.4 | 23 | dB |
| Amplitude Ripple |  |  | 0.4 | 1 | $\mathrm{dBp-p}$ |
| Phase Ripple |  |  | 1.5 | 2.5 | $\mathrm{degp-p}$ |
| Rejection |  | 54 | 57 |  | dB |
| Spurious for <br> $\left\|t-\mathrm{T}_{0}\right\|>.9 T_{0}$ |  |  | -43 | -42 | dB |
| Substrate Material |  |  | $128 \mathrm{YX}-\mathrm{LN}$ |  |  |

## Notes

1. Center Frequency $\left(F_{0}\right)$ and Bandwidth $(B)$ are defined, not measured.
2. Insertion Loss is the minimum loss for $\left|f-F_{0}\right|<.5 B$
3. Ripple spec applies to the $\left|f-\mathrm{F}_{0}\right|<.4 \mathrm{~B}$, and is doubled for $.4 \mathrm{~B}<\left|f-\mathrm{F}_{0}\right|<.5 \mathrm{~B}$
4. Rejection spec applies to ( $\mathrm{B}_{40}$ Spec - B / 2) $<\left|f-\mathrm{F}_{0}\right|<\mathrm{F}_{0} / 2$
5. Specifications are at $22^{\circ} \mathrm{C}$ only. Unit will operate undamaged from $-54^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ with shifts $\mathrm{dF}_{0}=-x^{*} \mathrm{~F}_{0}, \mathrm{dT}_{0}=x^{*} \mathrm{~T}_{0}$, where $x=75 \mathrm{E}-6^{*}$ (temperature $-22^{\circ} \mathrm{C}$ )

## Typical Performance

Frequency Response
(Best Fit Linear Phase Removed)

$10 \mathrm{~dB} / \mathrm{div}, 1 \mathrm{~dB} / \mathrm{div}$, $10 \mathrm{deg} / \mathrm{div}$, $6.500 \mathrm{MHz} / \mathrm{div}$

Impulse Response
FFT(Frequency Response* $\operatorname{Cos}\left(0.5^{*}\right.$ PI*MIN(1,MAX(0,|f-F0|*2.0/B-1.0)))^2)

$10 \mathrm{~dB} / \mathrm{div}, 0.800$ us/div

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## Package Outline



## Matching



## Microsemi

Power Matters."

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